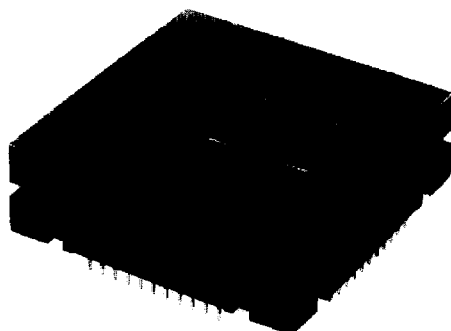


IC 200 SERIES QFP



FEATURES

- Open top type sockets for QFP packages.
- Unique contact design ensures increased density in burn-in board packaging.
- Lever operation ensures low actuation force and high durability.
- Unique contact design ensures outstanding contact reliability.

SPECIFICATIONS

PERFORMANCE

Insulation Resistance	IC200-1284-001: 1,000M Ω min. at 500VDC
	IC200-2084-009: } 1,000M Ω min. at 100VDC
	IC200-2084-010: }
Dielectric Withstanding Voltage	IC200-1284-001: 700VAC rms for 1 minute
	IC200-2084-009: } 1000VAC rms for 1 minute
	IC200-2084-010: }
Contact Resistance	30m Ω max. at 10mA
Operating Temperature Range	-40°C to +170°C

MATERIAL AND FINISH

Housing	PEI (glass-filled)
Contacts	Copper alloy, gold plating over nickel

ORDERING CODE

IC200—1284—001N—K

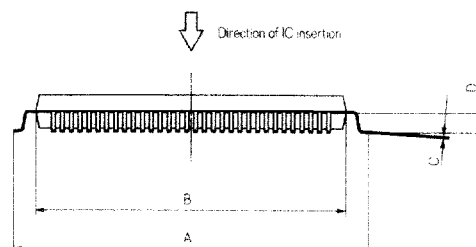
	Unmarked = without
	Protection key option K = with
	Unmarked = Both #1 and #2 pins
	Positioning pin option N = Without NN = With
	Design number (for internal use only)
	Number of leads
	IC200 series

●Applicable IC Dimensions (Reference Only)

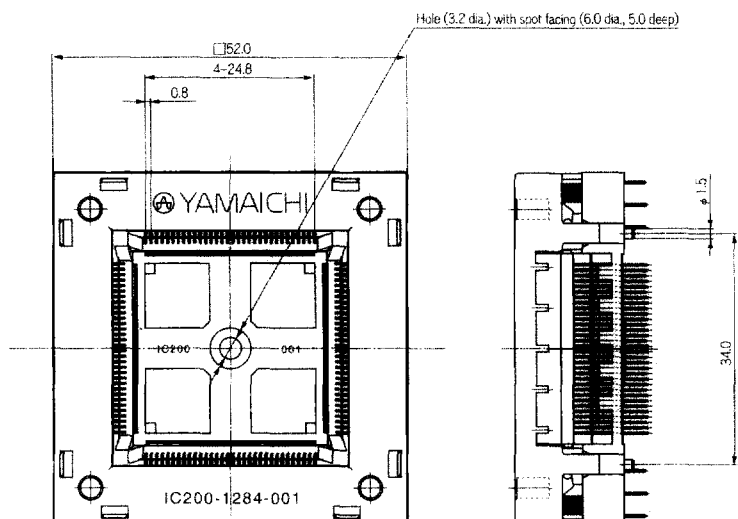
Part No.	No. of Leads	Pitch	A	B	C	D
IC200—1284—001	128	0.80	32.00	28.00	0.15	1.50MIN.
IC200—2084—009	208	0.50	31.20	28.03	0.15	1.40MIN.
IC200—2084—010	208	0.50	30.60	28.00	0.15	1.40MIN.

Unit = mm

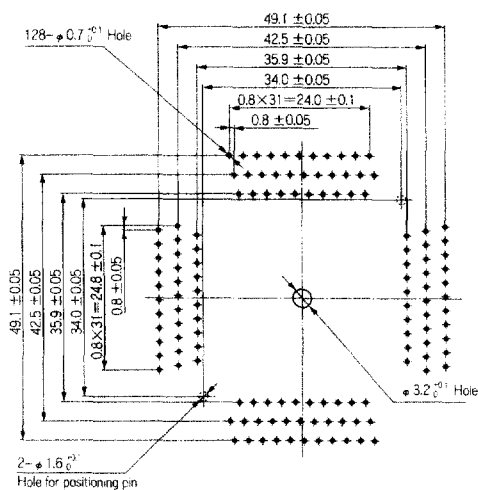
●Applicable IC Dimensions



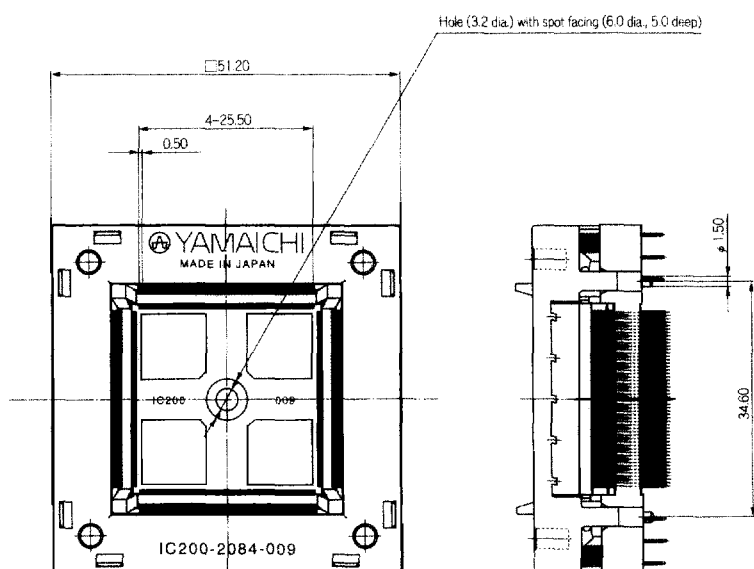
●IC200—1284—001



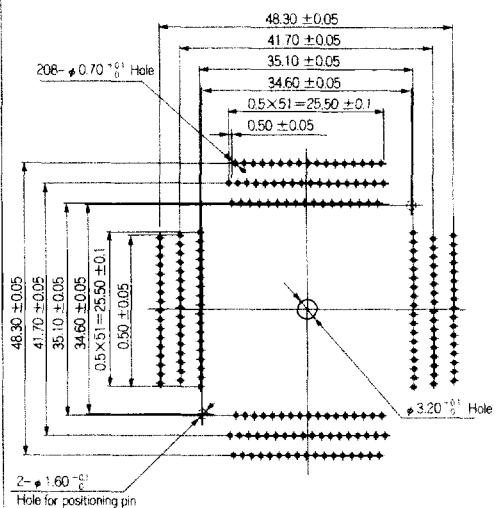
●Recommended PC Board Patterns (TOP VIEW)



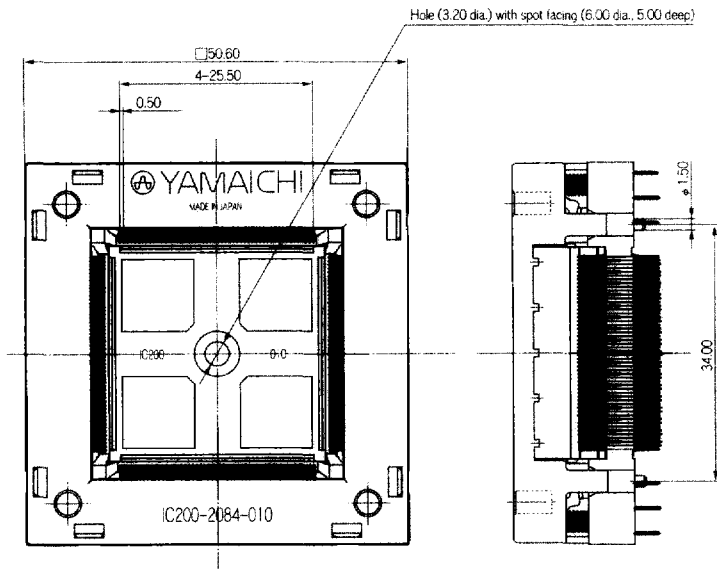
●IC200—2084—009



●Recommended PC Board Patterns (TOP VIEW)



●IC200—2084—010



●Recommended PC Board Patterns (TOP VIEW)

